

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L29	3991	(257/787).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/17 11:28
L30	1336	(257/E23.119).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/17 11:30
S1	1	"10552441"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 17:20
S2	1701	"epoxy resin" and "curing agent" and "inorganic filler"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 13:53
S3	1179	S2 AND @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 19:49
S4	331	S3 AND ("average particle size".or "maximum particle size")	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:12
S5	104	S3 and "specific surface area"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:11
S6	62	S4 AND S5	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 20:31
S7	1	2003-082243	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/12 20:34
S8	1	2001-151866	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/12 20:32

## EAST Search History

S9	4	"2003082243"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/12 20:49
S10	598	"JIS-K 6911" or "JIS K6911"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/12 20:58
S11	10	(encapsulating epoxy resin molding material).ti.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/12 21:01
S12	1	"10381052"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:09
S13	0	("10381052").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/12 21:09
S14	205	S3 and "surface area"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:12
S15	579	S3 AND ("average particle size" or "maximum particle size" or "particle size")	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:12
S16	160	S14 AND S15	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:50
S17	2716	"curing accelerator"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/12 21:51
S18	1108684	"coupling" or "coupling agent"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/12 21:51
S19	191071	phosphorus	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/12 21:51

## EAST Search History

S20	27	S16 AND S17 AND S18 AND S19	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 12:36
S21	1701	"epoxy resin" and "curing agent" and "inorganic filler"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 12:36
S22	1179	S21 AND @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 12:36
S23	205	S22 and "surface area"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 12:36
S24	579	S22 AND ("average particle size" or "maximum particle size" or "particle size")	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 12:36
S25	160	S23 AND S24	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 12:36
S26	2716	"curing accelerator"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 12:36
S27	1108684	"coupling" or "coupling agent"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 12:36
S28	191071	phosphorus	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 12:36
S29	27	S25 AND S26 AND S27 AND S28	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 12:36
S30	11	S29 AND aromatic	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 12:39
S31	2	S30 and phosphate	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 12:39
S32	2	("6376923").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/13 16:31
S33	1701	"epoxy resin" and "curing agent" and "inorganic filler"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 18:10

## EAST Search History

S34	1179	S33 AND @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 18:10
S35	205	S34 and "surface area"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 18:10
S36	579	S34 AND ("average particle size" or "maximum particle size" or "particle size")	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 18:10
S37	160	S35 AND S36	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 18:10
S38	2716	"curing accelerator"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/13 18:10
S39	1108684	"coupling" or "coupling agent"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 18:10
S40	191071	phosphorus	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 18:10
S41	27	S37 AND S38 AND S39 AND S40	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 21:35
S42	0	S41 and "melt density"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 18:54
S43	0	S37 and "melt density"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 18:54
S44	6	S41 and "phenol resin"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 18:17
S45	11	S41 and "melt viscosity"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 19:39
S46	32	S37 and "melt viscosity"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 18:54
S47	2	("20040082107").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/13 19:39

## EAST Search History

S48	4	("2003082243").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/13 19:56
S49	0	("2002-030240").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/13 20:15
S50	3	("2002030240").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/13 20:16
S51	3	"2002030240"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:18
S52	3	"2002-030240"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:17
S53	1	2003-082243	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:17
S54	1	"2003-082243"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:17

## EAST Search History

S55	4	"2003082243"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:21
S56	1	"2001-151866"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:21
S57	2	"2001151866"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:22
S58	212	masaji NEAR ogata	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:23
S59	212	ogata NEAR masaji	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/13 20:24
S60	1	ogata NEAR masaji	US-PGPUB; USPAT; USOCR; FPRS; EPO	AND	OFF	2007/04/13 20:24
S61	3	(S41 or S37) AND "phosphine oxide"	US-PGPUB; USPAT; USOCR	AND	ON	2007/04/13 21:36

## EAST Search History

S62	98	((("5912320") or ("6236108") or ("4326215") or ("5225499") or ("5998243") or ("6064111") or ("5298768") or ("4985751") or ("5567990") or ("5650177") or ("6054222") or ("6120716") or ("6122822") or ("6211277") or ("6211277") or ("6236568") or ("4298883") or ("4480975") or ("4872825") or ("4920404") or ("4931852") or ("5192995") or ("5207102") or ("5235005") or ("5248710") or ("5316463") or ("5367196") or ("5391924") or ("5405255") or ("5409362") or ("5424250") or ("5429488") or ("5445995") or ("5484274") or ("5557142") or ("5567656") or ("5594275") or ("5739187") or ("5753532") or ("5763540") or ("5808354") or ("5807768") or ("5821613") or ("5834836") or ("5841192") or ("5882692") or ("5894984") or ("5963796") or ("5986334") or ("6002173") or ("").pn.))).PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 11:12
S63	8	S62 and (phosphate or phosphine)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 11:13
S64	458	"epoxy resin" and "curing agent" and "inorganic filler" and "phosphate"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 12:23
S65	59	"epoxy resin" and "curing agent" and "inorganic filler" AND "phosphine oxide"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 11:21
S66	34	S65 and @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 11:21
S67	278	S64 and @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 11:21
S68	27	S66 and S67	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 11:41
S69	26	S68 and aromatic	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 11:44

## EAST Search History

S70	0	S68 and "aromatic phosphate"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 11:45
S71	1	S67 and "aromatic phosphate"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 12:23
S72	278	"epoxy resin" and "curing agent" and "inorganic filler" and "phosphate" AND alkyl AND aromatic	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 12:24
S73	163	S72 and @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 13:18
S74	76	S73 and "phosphoric acid"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 13:18
S75	2	("6319619").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 14:08
S76	2	("20030201548").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 14:24
S77	556	yamaguchi NEAR yoshio	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 14:24
S78	131	ikemura NEAR kazuhiko	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 14:25



## EAST Search History

S79	123	nishioka NEAR tsutomu	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 14:25
S80	7	S77 AND S78 AND S79	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 14:25
S81	2	("20040082107").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 16:04
S82	2	("6724091").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 16:04
S83	59	"epoxy resin" and "curing agent" and "inorganic filler" AND "phosphine oxide"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 16:16
S84	34	S83 and @ad<"20030407"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 16:18
S85	6	S84 and ("particle size" or "surface area")	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 16:18
S86	0	"warp of a semiconductor"	US-PGPUB; USPAT; USOCR	AND	OFF	2007/04/16 17:20
S87	0	"100770701"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 18:06

## EAST Search History

S88	9	"10077701".	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/04/16 18:09
S89	2	("6733698").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 18:11
S90	3	((("6733698") or ("20020168527"))).PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/16 18:11